

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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7-17-01

In re the Application of:

Philipp Steinmann et al. Examiner: TBD
Serial No: TBD Art Unit: TBD
Filed: 05/10/01 Docket No.: TI-29881
For: METHOD OF INTEGRATING A THIN FILM RESISTOR IN A MULTI-
LEVEL METAL TUNGSTEN-PLUG INTERCONNECT

PRELIMINARY AMENDMENT

May 10, 2001

Assistant Commissioner for Patents

Washington, DC 20231

Dear Sir:

Please amend the above referenced application as follows:

In the Specification:

Page 1, before line 1, insert This application claims priority under 35 USC §
119(e)(1) of provisional application numbers 60/208,705 filed 06/01/00.--

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